### 捷多邦,专业PCB打样工厂,24小时加**SNF**作ALVC16374 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOP WITH 3-STATE OUTPUTS

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- Member of the Texas Instruments
   Widebus™ Family
- EPIC™ (Enhanced-Performance Implanted CMOS) Submicron Process
- Typical V<sub>OLP</sub> (Output Ground Bounce)
   < 0.8 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot)
   2 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- Bus Hold On Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- ESD Protection Exceeds 2000 V Per MIL-STD-833C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JEDEC Standard JESD-17
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages

### description

This 16-bit edge-triggered D-type flip-flop is designed for 3.3-V V<sub>CC</sub> operation; it is tested at 2.5-V, 2.7-V, and 3.3-V V<sub>CC</sub>.

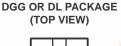
The SN74ALVC16374 is particularly suitable for implementing buffer registers, I/O ports,

bidirectional bus drivers, and working registers. It can be used as two 8-bit flip-flops or one 16-bit flip-flop. On the positive transition of the clock (CLK) input, the Q outputs of the flip-flop take on the logic levels set up at the data (D) inputs.  $\overline{OE}$ ) can be used to place the eight outputs in either a normal logic state (high- or low-logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines without need for interface or pullup components.  $\overline{OE}$  does not affect internal operations of the flip-flop. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74ALVC16374 is available in TI's shrink small-outline (DL) and thin shrink small-outline (DGG) packages, which provide twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN74ALVC16374 is characterized for operation from -40°C to 85°C.





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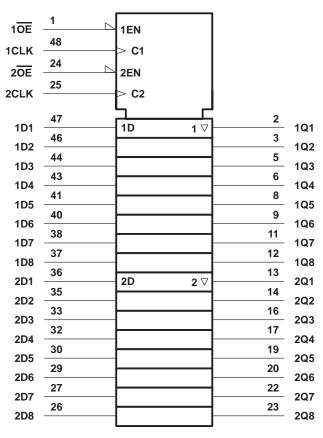
# 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOP

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#### **FUNCTION TABLE** (each flip-flop)

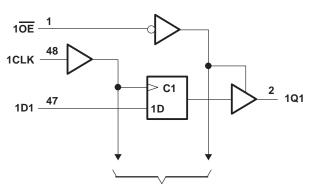
|    | INPUTS     |   | OUTPUT         |
|----|------------|---|----------------|
| OE | CLK        | D | Q              |
| L  | <b>↑</b>   | Н | Н              |
| L  | $\uparrow$ | L | L              |
| L  | H or L     | Χ | Q <sub>0</sub> |
| Н  | X          | Χ | Z              |

# logic symbol†

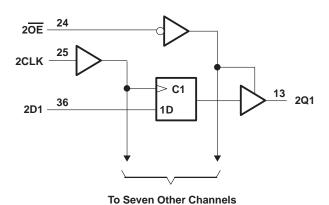


#### <sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### logic diagram (positive logic)



To Seven Other Channels



## SN74ALVC16374 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOP WITH 3-STATE OUTPUTS

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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V <sub>CC</sub> 0.5 V to 4.6 V  |
|---|
| Input voltage range, V <sub>I</sub> (see Note 1)  |
| Output voltage range, $V_O$ (see Notes 1 and 2)   |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )   |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) $\pm 50$ mA Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ ) $\pm 50$ mA |
| ,   |
|   |
|   |
|   |
| Continuous current through $V_{CC}$ or GND  |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

- 2. This value is limited to 4.6 V maximum.
- 3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.

### recommended operating conditions (see Note 4)

|                |   |  | MIN | MAX    | UNIT |
|----------------|---|--|-----|--------|------|
| Vсс            | Supply voltage  |  | 2.3 | 3.6    | V    |
| V              | High level input voltage  | V <sub>CC</sub> = 2.3 V to 2.7 V           | 1.7 |        | V    |
| VIH            | High-level input voltage $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ |  | 2   |        | V    |
| V              | Low level input voltage   | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ |     | 0.7    | V    |
| VIL            | Low-level input voltage   | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ |     | 0.8    | V    |
| ٧ <sub>I</sub> | Input voltage   |  | 0   | Vcc    | V    |
| ٧o             | Output voltage  |  | 0   | VCC    | V    |
|                |   | V <sub>CC</sub> = 2.3 V                    |     | -12    |      |
| ЮН             | High-level output current   | V <sub>CC</sub> = 2.7 V                    |     | -12 mA |      |
|                |   | VCC = 3 V                                  |     | -24    |      |
|                |   | V <sub>CC</sub> = 2.3 V                    |     | 12     |      |
| lOL            | Low-level output current  | V <sub>CC</sub> = 2.7 V                    |     | 12     | mA   |
|                | V <sub>CC</sub> = 3 V   |  |     | 24     |      |
| Δt/Δν          | Input transition rise or fall rate                                  |  | 0   | 10     | ns/V |
| TA             | Operating free-air temperature                                      |  | -40 | 85     | °C   |

NOTE 4: Unused or floating control pins must be held high or low.

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### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                      | DAMETER        | TEOT 001  | DITIONS                         | v <sub>cc</sub> † | T <sub>A</sub> = -  | 40°C to | 85°C | UNIT |  |
|----------------------|----------------|---|---------------------------------|-------------------|---------------------|---------|------|------|--|
| PARAMETER            |                | I IEST CON  | TEST CONDITIONS                 |                   |                     | TYP     | MAX  | UNII |  |
|                      |                | $I_{OH} = -100 \mu\text{A}$   |                                 | MIN to MAX        | V <sub>CC</sub> -0. | 2       |      |      |  |
|                      |                | I <sub>OH</sub> = -6 mA   | V <sub>IH</sub> = 1.7 V         | 2.3 V             | 2                   |         |      |      |  |
| \/                   |                |   | V <sub>IH</sub> = 1.7 V         | 2.3 V             | 1.7                 |         |      | V    |  |
| VOH                  |                | $I_{OH} = -12 \text{ mA}$   | V <sub>IH</sub> = 2 V           | 2.7 V             | 2.2                 |         |      | ٧    |  |
|                      |                |   | V <sub>IH</sub> = 2 V           | 3 V               | 2.4                 |         |      |      |  |
|                      |                | $I_{OH} = -24 \text{ mA}$   | V <sub>IH</sub> = 2 V           | 3 V               | 2                   |         |      |      |  |
|                      |                | I <sub>OL</sub> = 100 μA  |                                 | MIN to MAX        |                     |         | 0.2  |      |  |
|                      |                | I <sub>OL</sub> = 6 mA  | V <sub>IL</sub> = 0.7 mA        | 2.3 V             |                     |         | 0.4  |      |  |
| VOL                  |                | I <sub>OL</sub> = 12 mA   | V <sub>IL</sub> = 0.7 mA        | 2.3 V             |                     |         | 0.7  | V    |  |
|                      |                | I <sub>OL</sub> = 12 mA   | V <sub>IL</sub> = 0.8 mA        | 2.7 V             |                     |         | 0.4  |      |  |
|                      |                | I <sub>OL</sub> = 24 mA   | V <sub>IL</sub> = 0.8 mA        | 3 V               |                     |         | 0.55 |      |  |
| Ц                    |                | $V_I = V_{CC}$ or GND   |                                 | 3.6 V             |                     |         | ±5   | μΑ   |  |
|                      |                | V <sub>I</sub> = 0.7 V  | 2.3 V                           | 45                |                     |         |      |      |  |
|                      |                | V <sub>I</sub> = 1.7 V  | 2.3 V                           | -45               |                     |         | μΑ   |      |  |
| I <sub>I(hold)</sub> |                | V <sub>I</sub> = 0.8 V  |                                 | 3 V               | 75                  |         |      |      |  |
|                      |                | V <sub>I</sub> = 2 V  |                                 | 3 V               | -75                 |         |      |      |  |
|                      |                | V <sub>I</sub> = 0 to 3.6 V   |                                 | 3.6 V             |                     |         | ±500 |      |  |
| l <sub>OZ</sub> §    |                | $V_O = V_{CC}$ or GND   |                                 | 3.6 V             |                     |         | ±10  | μΑ   |  |
| ICC                  |                | $V_I = V_{CC}$ or GND,  | I <sub>O</sub> = 0              | 3.6 V             |                     |         | 40   | μΑ   |  |
| ∆lcc                 |                | V <sub>CC</sub> = 3 V to 3.6 V,<br>Other inputs at V <sub>CC</sub> or GND | One input at $V_{CC} - 0.6 V$ , |                   |                     |         | 750  | μА   |  |
| Ci                   | Control inputs | V <sub>I</sub> = V <sub>CC</sub> or GND                                   |                                 | 3.3 V             |                     | 3       |      | pF   |  |
| <u> </u>             | Inputs         | AL = ACC OLOUP  |                                 | 3.5 v             |                     | 6       |      | ы    |  |
| Co                   |                | $V_O = V_{CC}$ or GND   |                                 | 3.3 V             |                     | 7       |      | pF   |  |

<sup>†</sup> For conditions shown as MIN or MAX use the appropriate values under recommended operating conditions.

# timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 and 2)

|                 |                                 | V <sub>CC</sub> = 2.5 V<br>± 0.2 V |     |     |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | UNIT |
|-----------------|---------------------------------|------------------------------------|-----|-----|-----|------------------------------------|-----|------|
|                 |                                 | MIN                                | MAX | MIN | MAX | MIN                                | MAX |      |
| fclock          | Clock frequency                 | 0                                  | 150 | 0   | 150 | 0                                  | 150 | MHz  |
| t <sub>W</sub>  | Pulse duration, CLK high or low | 3.3                                |     | 3.3 |     | 3.3                                |     | ns   |
| t <sub>su</sub> | Setup time, data before CLK↑    | 2.1                                |     | 2.2 |     | 1.9                                |     | ns   |
| t <sub>h</sub>  | Hold time, data after CLK↑      | 0.6                                |     | 0.5 |     | 0.5                                |     | ns   |



<sup>§</sup> For I/O ports, the parameter IOZ includes the input leakage current.

# SN74ALVC16374 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOP WITH 3-STATE OUTPUTS SCAS258A – JANUARY 1993 – REVISED MAY 1995

# switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 and 2)

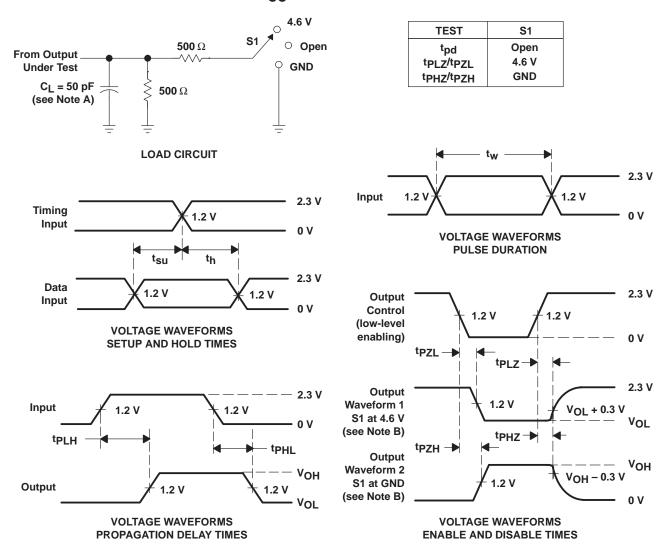
| PARAMETER        | FROM<br>(INPUT) | TO (OUTPUT) | V <sub>CC</sub> = 2.5 V<br>± 0.2 V |     | V <sub>CC</sub> = 2.7 V |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | UNIT |
|------------------|-----------------|-------------|------------------------------------|-----|-------------------------|-----|------------------------------------|-----|------|
|                  | (INPUT)         | (OUTPUT)    | MIN                                | MAX | MIN                     | MAX | MIN                                | MAX |      |
| f <sub>max</sub> |                 |             | 150                                |     | 150                     |     | 150                                |     | MHz  |
| t <sub>pd</sub>  | CLK             | Q           | 1                                  | 5.9 |                         | 4.9 | 1                                  | 4.2 | ns   |
| t <sub>en</sub>  | CLK             | Q           | 1                                  | 6.7 |                         | 5.9 | 1                                  | 4.8 | ns   |
| <sup>t</sup> dis | CLK             | Q           | 1.7                                | 5.5 |                         | 4.7 | 1.2                                | 4.3 | ns   |

# operating characteristics, $T_A = 25^{\circ}C$

| PARAMETER       |                  | TEST CONDITIONS                            | V <sub>CC</sub> = 2.5 V<br>± 0.2 V | V <sub>CC</sub> = 3.3 V<br>± 0.3 V | UNIT |  |
|-----------------|------------------|--|------------------------------------|------------------------------------|------|--|
|                 |                  |  | TYP                                | TYP                                |      |  |
| C .             | Outputs enabled  | C 50 pE                                    | 31                                 | 30                                 | pF   |  |
| C <sub>pd</sub> | Outputs disabled | $C_L = 50 \text{ pF},  f = 10 \text{ MHz}$ | 16                                 | 18                                 |      |  |

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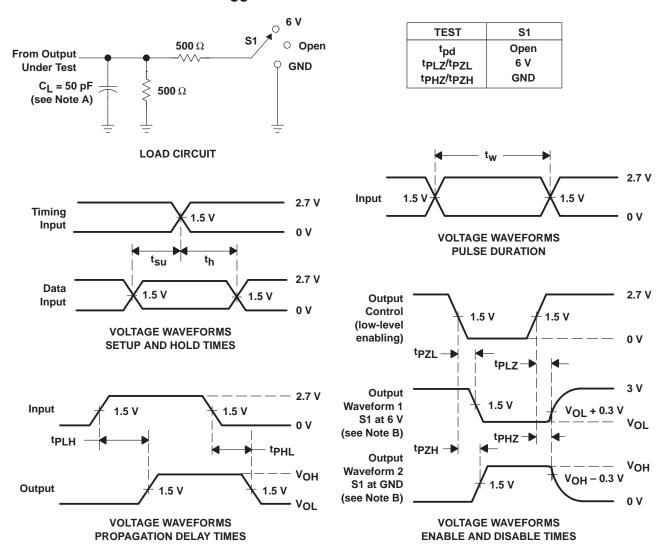
# PARAMETER MEASUREMENT INFORMATION $V_{CC}$ = 2.5 V $\pm$ 0.2 V



- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_Q = 50 \Omega$ ,  $t_f \leq 2.5 \text{ ns.}$   $t_f \leq 2.5 \text{ ns.}$
  - D. The outputs are measured one at a time with one transition per measurement.
  - E. tpLZ and tpHZ are the same as tdis.
  - F. tpzL and tpzH are the same as ten.
  - G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms

### PARAMETER MEASUREMENT INFORMATION $V_{CC}$ = 2.7 V AND 3.3 V $\pm$ 0.3 V



- NOTES: A. C<sub>I</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \,\Omega$ ,  $t_f \leq 2.5 \,\text{ns}$ ,  $t_f \leq 2.5 \,\text{ns}$ .
  - D. The outputs are measured one at a time with one transition per measurement.
  - E. tpLz and tpHz are the same as tdis.
  - F. tpzL and tpzH are the same as ten.
  - G. tpLH and tpHL are the same as tpd.

Figure 2. Load Circuit and Voltage Waveforms





### PACKAGE OPTION ADDENDUM

30-Mar-2005

### **PACKAGING INFORMATION**

| Orderable Device  | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins Package<br>Qty | Eco Plan (2) | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|-------------------|-----------------------|-----------------|--------------------|---------------------|--------------|------------------|------------------------------|
| SN74ALVC16374DGGR | OBSOLETE              | TSSOP           | DGG                | 48                  | TBD          | Call TI          | Call TI                      |
| SN74ALVC16374DL   | OBSOLETE              | SSOP            | DL                 | 48                  | TBD          | Call TI          | Call TI                      |
| SN74ALVC16374DLR  | OBSOLETE              | SSOP            | DL                 | 48                  | TBD          | Call TI          | Call TI                      |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

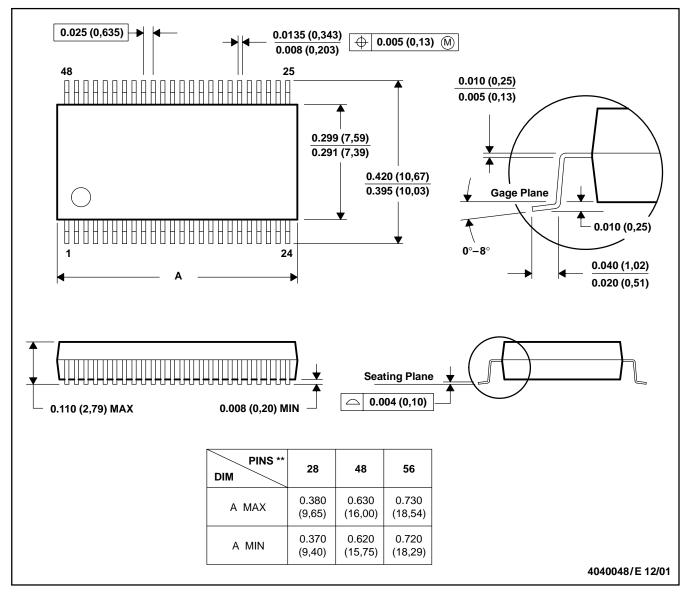
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### DL (R-PDSO-G\*\*)

### **48 PINS SHOWN**

### PLASTIC SMALL-OUTLINE PACKAGE



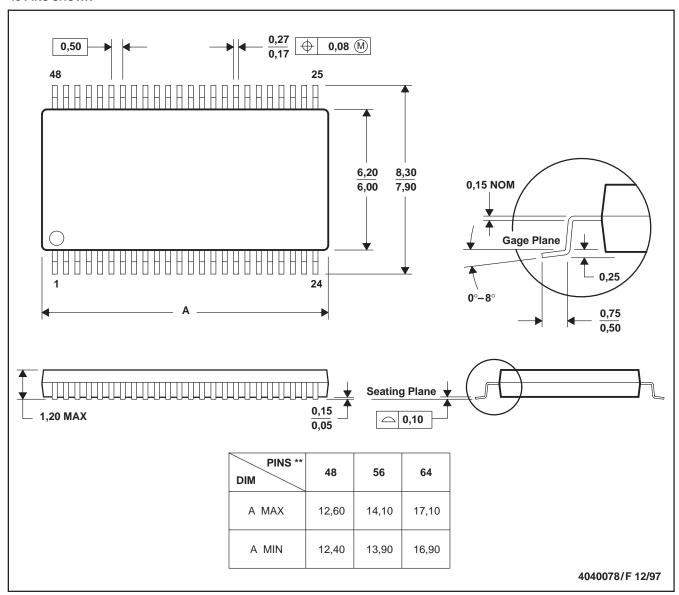
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

### DGG (R-PDSO-G\*\*)

### PLASTIC SMALL-OUTLINE PACKAGE

### **48 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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